AW318B Datasheet

Zhuhai Jieli Technology Co.,LTD

Version 1.1

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Revision History

| Date | Revision | Description | |
|------------|----------|-------------------------------|--|
| 2024.04.12 | V1.0 | Initial Release | |
| 2024.07.04 | V1.1 | Update IC Marking Information | |
| | | | |





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AW318B Features

SYSTEM

- 32bit CPU 160MHz
- ➤ Support MATH/AES128
- I-cache
- Support EMU
- On-chip SRAM 32kbyte
- Support MPU
- Support UDMA
- ➢ Built-In Flash
- ➤ 24MHz crystal oscillator
- > Internal low jitter low power RC oscillator
- Internal PLL

Bluetooth

- BLE5.4 +2.4GHz-Proprietary (QDID 223418)
- Support AoA Transmitter
- Support long range BLE
- Maximum transmitting power 8dBm
- Receiver sensitivity
 - ◆ -92dBm @BLE-1Mbps
 - ❖ -89dBm @BLE-2Mbps

Peripherals

- 1 x Full speed USB
- 4 x Multi-function 32bit timer
- ➤ 1 x IR RX/TX
- ➤ 1 x UART interface
- 1 x I²C Master/Slave interface
- 2 x SPI Master/Slave interface
- ➤ 1 x QDEC
- ➤ 2 x MCPWM
- ➤ 2 x LEDC
- 1 x 10bit ADC(2 Channel)
- 1 x GPIO Support function remapping

PMU

- Support temperature sensor
- ➤ VPWR range 2.7V to 5.5V
- ➤ IOVDD range 1.8V to 3.6V
- > Deep sleep mode (IOVDD @3.0V)
 - 170nA (External wakeup)
 - 1.37uA (32kHz RC OSC+wakeup)
 - 2.9uA (32kHz RC OSC+wakeup+16k retention SRAM)

Packages

➤ SOP8

Temperature

- Operating temperature
 - TC = -20° C to $+85^{\circ}$ C (standard range)
 - $TC = -40^{\circ}C$ to $+105^{\circ}C$ (extended range)
- Storage temperature -65℃ to +150℃

Applications

- Mouse devices
- Non-audio remote controller
- Selfie stick
- Page turner
- Adaptive USB
- Bluetooth moudle
- Price tag and other diversified IOT product



1 Block Diagram

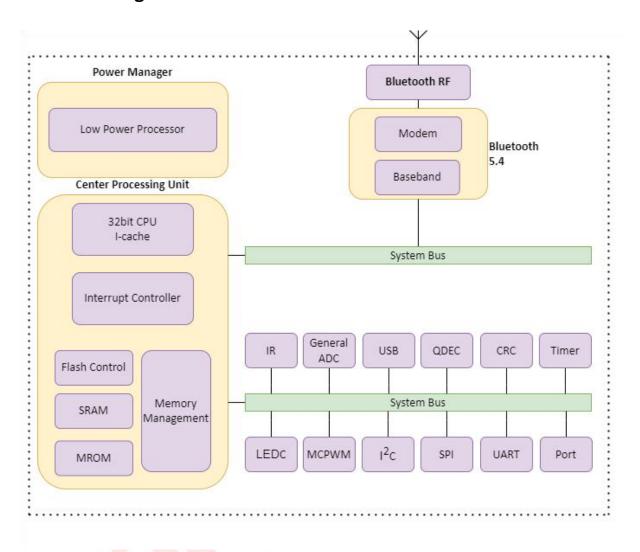


Figure 1-1 AW318B Block Diagram



2 Pin Definition

2.1 Pin Assignment

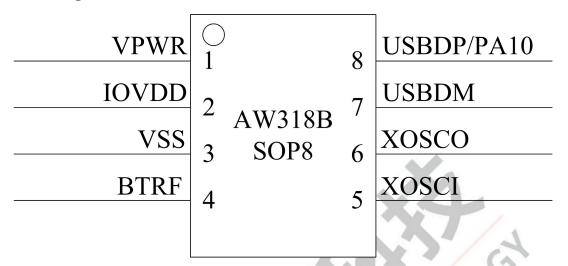


Figure 2-1 AW318B Pin Assignment

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2.2 Pin Description

Table 2-2-1 AW318B Pin Description

| Pin No. | Name | Туре | IO Initial State | Description |
|---------|-------|------|---------------------|-----------------------------|
| 1 | VPWR | Р | | Battery Input |
| 2 | IOVDD | Р | | IO Power |
| 3 | VSS | G | | Ground |
| 4 | BTRF | RF | | Bluetooth RF Antenna |
| 5 | XOSCI | ı | | Crystal Oscillator Input |
| 6 | xosco | 0 | | Crystal Oscillator Output |
| 7 | USBDM | 1/0 | 15kΩ Pull-down | ADC13(ADC Input Channel 13) |
| 0 | USBDP | 1/0 | 15kΩ Pull-down | ADC14(ADC Input Channel 14) |
| 8 | PA10 | 1/0 | Z | ADC10(ADC Input Channel 10) |

Note

- 1.IO initial state abbreviations Z--High resistance, H--High level, L--Low level, X--May be changed during power on.
- 2.Timer, IR,MCPWM, QDEC, UART, LEDC, I²C, SPI1 functions can be remapped to any I/O.

Table 2-2-2 Pin Types Description

| Pin Type | Description | Pin Type | Description |
|----------|-------------|----------|-----------------|
| Р | Power | 1/0 | Input or Output |
| G | Ground | 1 | Input |
| RF | RF antenna | 0 | Output |



3 Electrical Characteristics

3.1 Absolute Maximum Ratings

Table 3-1 Absolute Maximum Ratings

| Symbol | Parameter | Min | Max | Unit |
|--------|------------------------------------|------|------|------------|
| Topt | Operating temperature | -20 | +85 | $^{\circ}$ |
| Tstg | Storage temperature | -65 | +150 | $^{\circ}$ |
| VPWR | Const. Wells as | -0.3 | 6.0 | V |
| IOVDD | Supply Voltage | -0.3 | 3.6 | V |
| GPIO | Input voltage of GPIO (except PA7) | -0.3 | 3.6 | V |

Note

3.2 ESD Ratings

Table 3-2 ESD Ratings

| Parameter | Тур | Test pin | Reference standard |
|---------------------|-------|----------|-----------------------------|
| Human Body Mode | ±8kV | All pins | JEDEC EIA/JESD22-A114 |
| Machine Mode | ±400V | All pins | JEDEC EIA/JESD22-A115 |
| Charge Device Model | ±2kV | All pins | ANSI/ESDA/JEDEC JS-002-2022 |

3.3 PMU Characteristics

Table 3-3-1 PMU Characteristics under VPWR supply

| The contract of the contract o | | | | | | |
|--|-----------------|------------------------|-----|-----|-----|------|
| Symbol | Parameter | Conditions | Min | Тур | Max | Unit |
| VPWR | Power supply | | 2.7 | | 5.5 | ٧ |
| Operating mo | Operating mode | | | | | |
| Symbol | Parameter | Conditions | Min | Тур | Max | Unit |
| IOVDD | Voltage output | | | 3.0 | | V |
| טטעטו | Loading current | IOVDD=3.0V@VPWR = 3.7V | | | 60 | mA |
| Low Power m | ode | | | | | |
| Symbol | Parameter | Conditions | Min | Тур | Max | Unit |
| IOVDD | Loading current | IOVDD=3.0V@VPWR = 3.7V | | | 8 | mA |

Table 3-3-2 PMU Characteristics under IOVDD supply

| Symbol | Parameter | Conditions | Min | Тур | Max | Unit |
|--------|--------------|------------|-----|-----|-----|------|
| IOVDD | Power supply | - | 1.8 | - | 3.6 | V |

^{1.}Stresses beyond those listed under absolute maximum ratings may cause permanent damage to the device.



3.4 IO Characteristics

Table 3-4 IO Characteristics

| Innest Char | un aka ulakina | | aracteristics | | | |
|-----------------|----------------------------|--------------------------------|----------------|--|--------------------------|---------------------------------------|
| | racteristics | | | | | |
| Symbol | Parameter | Conditions | 10 | Min | Max | Unit |
| V_{IL} | Low-Level Input Voltage | IOVDD = 3.0V | PA10 | -0.3 | 1.4 | V |
| V_{IH} | High-Level Input Voltage | IOVDD = 3.0V | USBDP | 1.7 | 3.3 | V |
| VIH | Trigit-Level input voitage | 10 V D D = 3.0 V | USBDM | 1.7 | 3.3 | \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ |
| Output Ch | aracteristics | | | | | |
| Symbol | Parameter | Conditions | 10 | Т | ур | Unit |
| I _{OL} | Output Current | IOVDD = 3.0V Voutput = 0.3V | PA10 | 9(H 21(F | D=0) D=1) HD=2) | mA |
| , 52, | | IOVDD = 3.0V Voutput = 0.3V | USBDP USBDM | 54(HD=3) 8 | | mA |
| Іон | Output Current | IOVDD = 3.0V Voutput = 2.7V | PA10 | 3(HD=0) 9(HD=1) 21(HD=2) 54(HD=3) | | mA |
| | | IOVDD = 3.0V Voutput = 2.7V | USBDP USBDM | 8 | | mA |
| Internal R | esistance Characteristics | | | | | |
| Symbol | Parameter | Conditions | 10 | Т | ур | Unit |
| | | IOVDD = 3.0V | PA10 | 100k | PU=1) (PU=2) | Ω |
| R_{pu} | Pull-up Resistance |) | | 1M(| PU=3) | |
| | | IOVDD = 3.0V | USBDP | 1 | .5k | Ω |
| | | IOVDD = 3.0V | USBDM | 18 | 30k | Ω |
| R_{pd} | Pull-down Resistance | IOVDD = 3.0V | PA10 | 100k | PD=1) (PD=2) PD=3) | Ω |
| | | IOVDD = 3.0V | USBDP USBDM | 15k | | Ω |

Note

1.Internal pull-up/pull-down resistance accuracy ±20%.



3.5 BT Characteristics

3.5.1 Transmitter

Table 3-5-1 Transmitter characteristics

| Parameter | Conditions | Min | Тур | Max | Unit |
|---------------------------|------------|-----|-----|-----|------|
| Maximum RF Transmit Power | BLE-1Mbps | | 7 | 8 | dBm |

3.5.2 Receiver

Table 3-5-2 Receiver characteristics

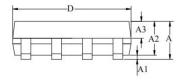
| Parameter | Conditions | Min | Тур | Max | Unit |
|-------------|------------|-----|-----|-----|------|
| Sensitivity | BLE-1Mbps | | -92 | | dBm |
| | BLE-2Mbps | / | -89 | | dBm |
| | BLE-S2 | | -94 | 1 | dBm |
| | BLE-S8 | - | -99 | // | dBm |

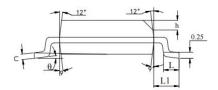


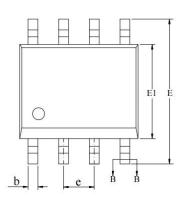


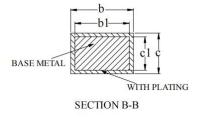
4 Package Information

4.1 SOP8









MILLIMETER SYMBOL NOM MAX MIN A 1.75 0.225 A1 0.10 1.30 1.50 A2 0.70 A3 0.60 0.39 0.47 b bl 0.38 0.44 0.41 0.20 0.24 0.19 0.20 0.21 c1 D 4.80 5.00 E 5.80 6.20 El 3.80 4.00 3.90 e 1.27BSC 0.50 h 0.25 0.50 0.80 L Ll 8° θ 0

Figure 4-1 AW318B Package



5 IC Marking Information

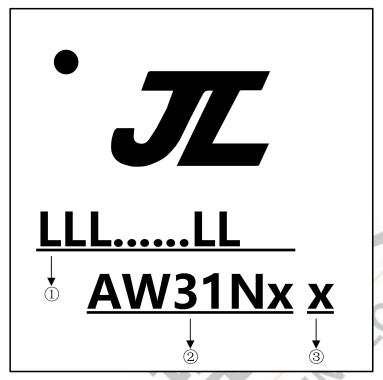


Figure 5-1 AW318B Package Outline

- 1 LLL.....LL LOT No. , It contains 7 to 18 alphanumerics
- 2 AW31Nx Chip Model
- (3) x Built-in flash size
 - 0 No Flash Memory
 - 2 2Mbit Flash
 - 4 4Mbit Flash



6 Solder-Reflow Condition

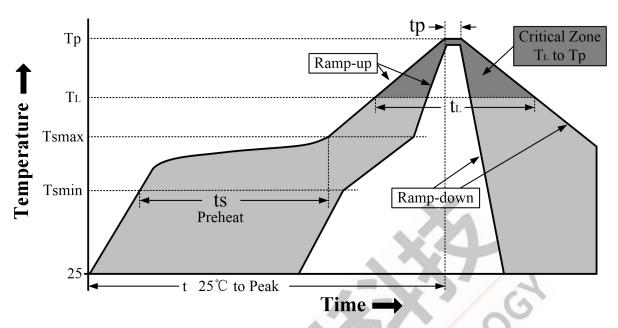


Figure 6-1 Classification Reflow Profile

Table 6-1 Classification Profiles

| | Profile Feature | Sn-Pb Eutectic Assembly | Pb-Free Assembly |
|--|--|-------------------------|------------------|
| | Temperature Min (T _{smin}) | 100℃ | 150℃ |
| Preheat/Soak | Temperature Max (T _{smax}) | 150°C | 200℃ |
| | Time (ts) from (T _{smin} to T _{smax}) | 60-120 seconds | 60-180 seconds |
| Average ramp- | up rate (T _{smax} to T _p) | 3℃/second max | 3℃/second max |
| Liquidus temperature (T _L) | | 183℃ | 217℃ |
| Time (t _L) maint | ained above T∟ | 60-150 seconds | 60-150 seconds |
| Peak package b | ood <mark>y temperature (T_p)</mark> | See Table 6-2 | See Table 6-3 |
| Time within 5°0 | C of actual | 10-30 seconds | 20-40 seconds |
| Peak Temperature (tp) ² | | 10-50 Seconds | 20-40 seconds |
| Ramp-down rate $(T_p \text{ to } T_L)$ | | 6℃/second max | 6℃/second max |
| Time 25℃ to p | eak temperature | 6 minutes max | 8 minutes max |

Note

- 1.All temperatures refer to topside of the package, measured on the package body surface
- 2.Time within 5 $^{\circ}$ C of actual peak temperature (tp) specified for the reflow profiles is a "supplier" and "user" maximum.

Table 6-2 SnPb Classification Temperature

| Package | Volume mm ³ | Volume mm³ ≥ 350 | |
|-----------|------------------------|---------------------|--|
| Thickness | < 350 | | |
| <2.5 mm | 240 +0/-5℃ | 225 +0/-5°C | |
| ≥2.5 mm | 225 +0/-5℃ | 225 +0/-5°C | |



Table 6-3 Pb-free - Classification Temperature

| | · | | |
|----------------|------------|------------|--------------|
| Package | Volume mm³ | Volume mm³ | Volume mm³ |
| Thickness | < 350 | 350 - 2000 | > 2000 |
| < 1.6mm | 260℃ | 260℃ | 260 ℃ |
| 1.6 mm - 2.5mm | 260℃ | 250℃ | 245℃ |
| > 2.5mm | 250℃ | 245℃ | 245℃ |

Note

1.*Tolerance The device manufacturer/supplier shall assure process compatibility up to and including the stated classification temperature (this means Peak reflow temperature +0 $^{\circ}$ C.For example 260 $^{\circ}$ C+0 $^{\circ}$ C)at the rated MSL level.

